Si4618DY Vishay Siliconix



| Parameter | Symbol | Test Conditions | | Min. | Typ. ^a | Max. | Unit | |
|---|-------------------------|---|--------------|------|-------------------|----------|------|--|
| Static | <u> </u> | | | | 1 | | | |
| Drain Course Breakdown Voltage | V | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$ Ch-1 | | 30 | | | V | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 1 mA Ch-2 | | 30 | | | | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | Ch-1 | | 35 | | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | Ch-1 | | - 6 | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$ | = 1 mA Ch-1 | | | 2.5 | | |
| | | $V_{DS} = V_{GS}, I_D = 1 \text{ mA}$ Ch | | 1 | | 2.5 | | |
| Gate-Body Leakage | I _{GSS} - | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$ | Ch-1 | | | 100 | μΑ | |
| | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$ Ch-2 | | | | 100 | | |
| | I _{DSS} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | Ch-1 | | | 0.001 | 001 | |
| | | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 \text{ °C}$ C | | | 0.05 | 0.5 | mA | |
| Zero Gate Voltage Drain Current | | | | | | 0.025 | | |
| | | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$ | Ch-2 | | 3 | 15 | | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 10 V | Ch-1 | 20 | | | A | |
| | | V _{DS} = 5 V, V _{GS} = 10 V | Ch-2 | 20 | | | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 8 A | Ch-1 | | 0.014 | 0.017 | _ | |
| | | V _{GS} = 10 V, I _D = 8 A | Ch-2 | | 0.0083 | 0.010 | | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$ | Ch-1 | | 0.016 | 0.0195 | | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$ | Ch-2 | | 0.0095 | 0.0115 | | |
| | | V _{DS} = 15 V, I _D = 8 A | Ch-1 | | 40 | | s | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 8 A Ch-2 | | | 47 | | | |
| Dynamic ^a | | | | | | | | |
| Input Congoitones | C _{iss} | | Ch-1 | | 1535 | | pF | |
| Input Capacitance | | Channel-1 V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz | Ch-2 | | 2290 | | | |
| Output Capacitance | C _{oss} | V _{DS} = 13 v, v _{GS} = 0 v, 1 = 1 lvll 12 | Ch-1 | | 205 | | | |
| | | Channel-2 | Ch-2 | | 360 | | | |
| Reverse Transfer Capacitance | C _{rss} | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | Ch-1 | | 91 | | | |
| | | V - 15 V V - 10 V I - 9 A | Ch-2 | | 117 | 4.4 | | |
| | Qg | V _{DS} = 15 V, V _{GS} = 10 V, I _D = 8 A | Ch-1 | | 29 | 44 | nC | |
| Total Gate Charge | | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$ | Ch-2 | | 39 | 59 | | |
| | | Channel-1 | Ch-1 Ch-2 | | 12.5 17 | 19 26 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 8 \text{ A}$ | Ch-1 | | 4.1 | 20 | | |
| | | Channel-2 | Ch-2 | | 5.6 | | | |
| Octo Paris Observe | Q _{gd} | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$ | Ch-1 | | 3.4 | | | |
| Gate-Drain Charge | | D3 15 1, 103 110 1, 10 0 11 | Ch-2 | | 4 | | | |
| Gate Resistance | R_{g} | f = 1 MHz | Ch-1 | | 1.8 | 3.0 | Ω | |
| Gate Hesistance | ' 'g | 1 — 1 1411 12 | Ch-2 | | 1.9 | 3.0 | 5.2 | |



| Parameter | Symbol | Test Conditions | | Min. | Typ. ^a | Max. | Unit |
|--|---------------------|--|--------------|--------|-------------------|-----------|------|
| Dynamic ^a | • | | | | | | |
| Turn-On Delay Time | t _{d(on)} | Observation | Ch-1 | | 8 | 15 | |
| Turn On Belay Time | -u(on) | Channel-1 $V_{DD} = 15 \text{ V, R}_{I} = 3 \Omega$ | Ch-2 | | 9 | 16 | ns |
| Rise Time | t _r | $I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$ | Ch-1 | | 22 | 33 | |
| | | | Ch-2 | | 24 | 36 | |
| Turn-Off Delay Time | V _{DD} = | Channel-2 | Ch-1 | | 20 | 30 | |
| • | | $V_{DD} = 15 \text{ V}, R_L = 3 \Omega$ | Ch-2 | | 26 | 39 | |
| Fall Time | t _f | $I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | Ch-1 | | 8 | 15 | |
| | | | Ch-2 | | 8 | 15 | |
| Turn-On Delay Time | t _{d(on)} | Channel-1 | Ch-1 | | 24 | 36 | |
| , | 4(011) | $V_{DD} = 15 \text{ V}, R_L = 3 \Omega$ | Ch-2 | | 24 | 36 | |
| Rise Time | t _r | $I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$ | Ch-1 | | 87 | 130 | |
| | • | D ALIV A | Ch-2 Ch-1 | | 97 30 | 145 45 | |
| Turn-Off Delay Time | t _{d(off)} | Channel-2 $V_{DD} = 15 \text{ V}, R_L = 3 \Omega$ | | | | | |
| | t _f | | Ch-2 Ch-1 | | 35 34 | 53 51 | |
| Fall Time | | $I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | Ch-2 | | 45 | 68 | |
| Drain-Source Body Diode Characteristi | l CS | | OII-Z | | 45 | 00 | |
| Continuous Source-Drain Diode Current | Is | T 05.00 | Ch-1 | | | 1.8 | |
| | | T _C = 25 °C | Ch-2 | | | 3.8 | |
| | I _{SM} | C | | | | 35 | Α |
| Pulse Diode Forward Current ^a | | | Ch-2 | | | 35 | |
| Body Diode Voltage | V _{SD} | I _S = 2 A | Ch-1 | 0.77 1 | | 1.1 | |
| | | I _S = 1 A | Ch-2 | | 0.37 | 0.43 | V |
| | t _{rr} | - | Ch-1 | | 22 | 33 | ns |
| Body Diode Reverse Recovery Time | | | Ch-2 | | 26 | 39 | |
| Body Diode Reverse Recovery Charge | Q _{rr} | Channel-1 | Ch-1 | | 15 | 23 | nC |
| | | $I_F = 4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | Ch-2 | | 15 | 23 | |
| Reverse Recovery Fall Time | t _a | Channel-2 | Ch-1 | | 13 | | ns |
| | | $I_F = 4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_{.I} = 25 ^{\circ}\text{C}$ | Ch-2 | | 13 | | |
| Daversa Dasavery Disa Tima | t _b | | Ch-1 | | 9 | | |
| Reverse Recovery Rise Time | | | Ch-2 | | 13 | | ĺ |

Notes:

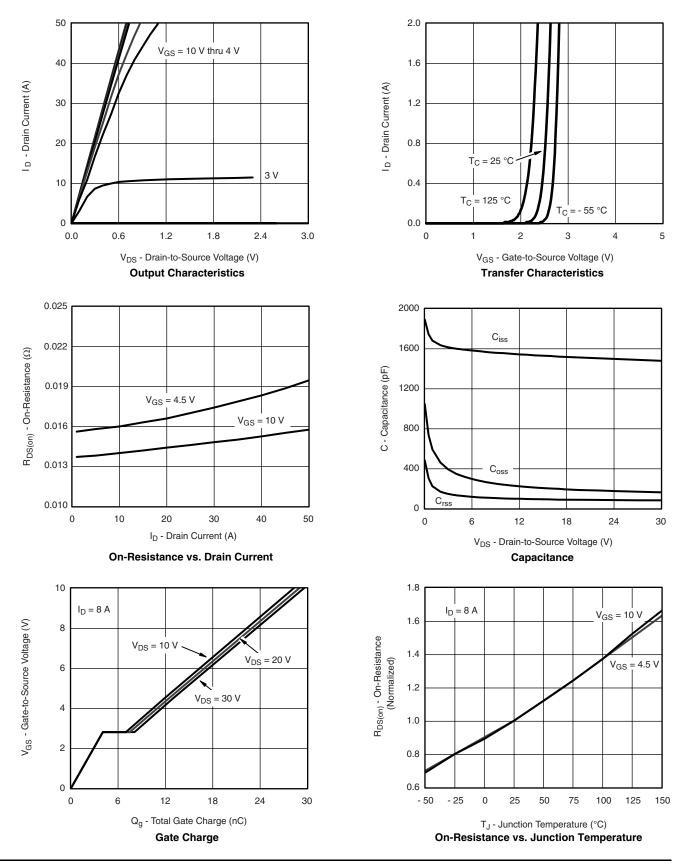
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

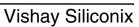
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

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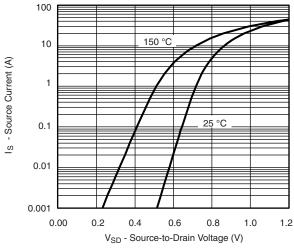
CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



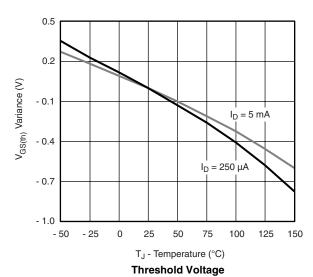




CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

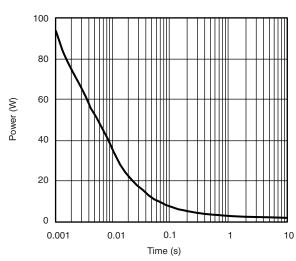


Source-Drain Diode Forward Voltage

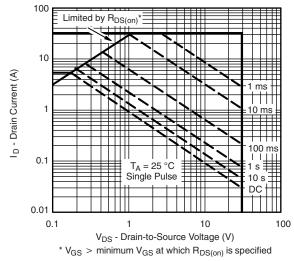


0.10
| O.08 | O.08 | O.06 | O.04 | O.02 | O.00 | O.

On-Resistance vs. Gate-to-Source Voltage



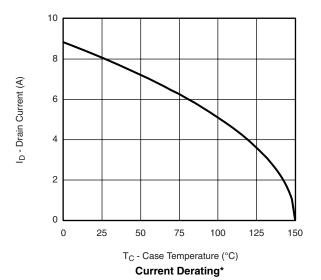
Single Pulse Power, Junction-to-Ambient

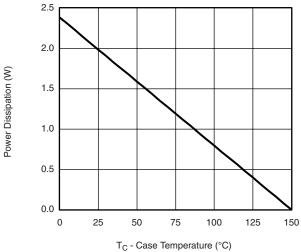


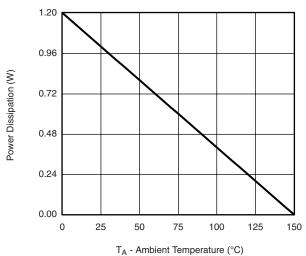
Safe Operating Area, Junction-to-Ambient

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CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







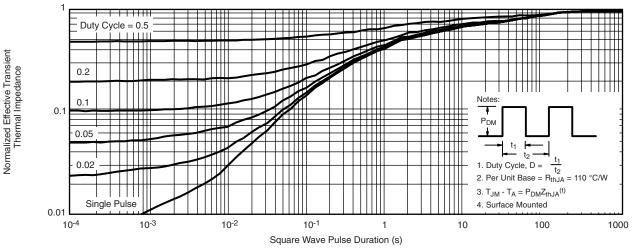
Power Derating, Junction-to-Ambient

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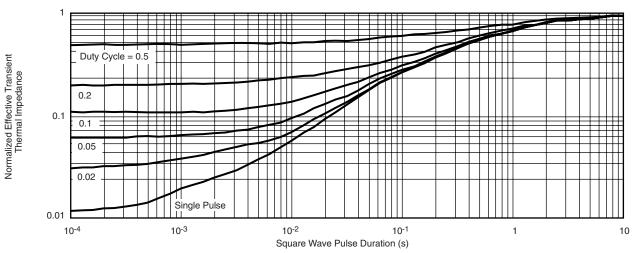
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



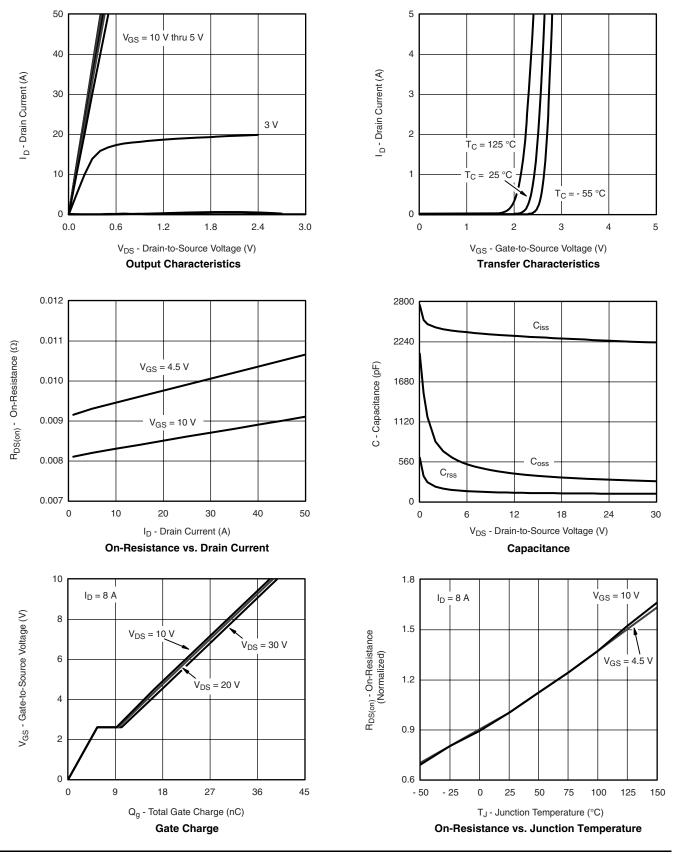
Normalized Thermal Transient Impedance, Junction-to-Ambient

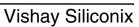


Normalized Thermal Transient Impedance, Junction-to-Foot

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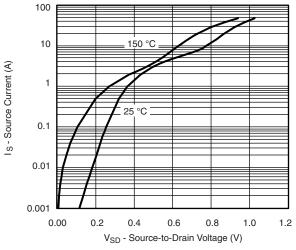
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

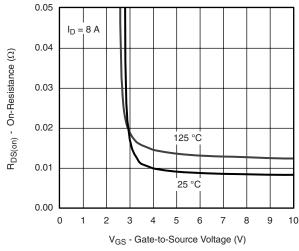






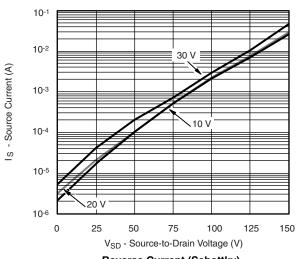
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

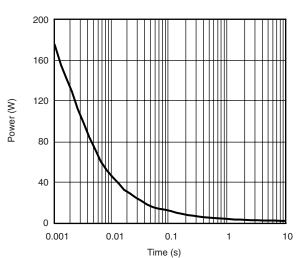




Source-Drain Diode Forward Voltage

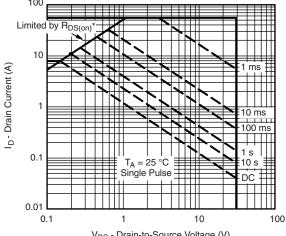






Reverse Current (Schottky)

Single Pulse Power, Junction-to-Ambient

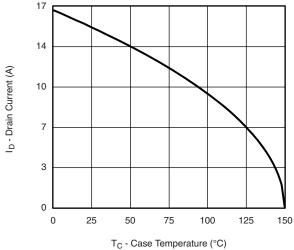


 $V_{DS} \mbox{ - Drain-to-Source Voltage (V)} $$ ^*V_{GS} > minimum V_{GS} \mbox{ at which } R_{DS(on)} \mbox{ is specified} $$$

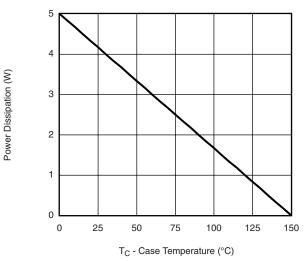
Safe Operating Area, Junction-to-Ambient

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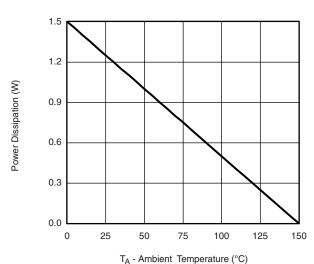
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*







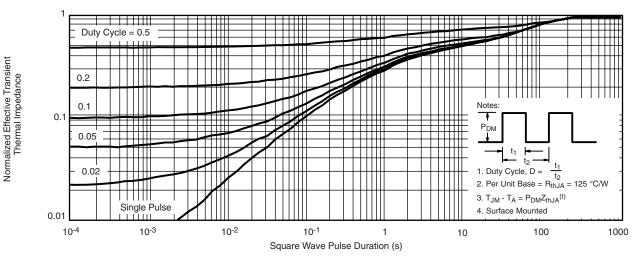
Power Derating, Junction-to-Ambient

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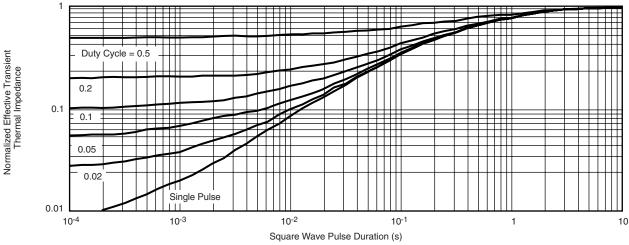
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

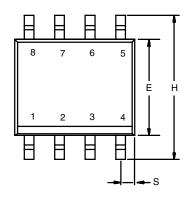


Normalized Thermal Transient Impedance, Junction-to-Foot

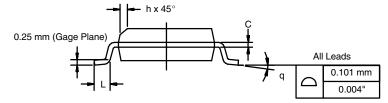
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Document Number: 74450 S09-2109-Rev. B, 12-Oct-09

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







| | MILLIM | IETERS | INCHES | | | |
|----------------|---------------------|--------|--------|-----------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 | 0.050 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-0652 | 27-Rev. I. 11-Sep-0 | 6 | | | | |

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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